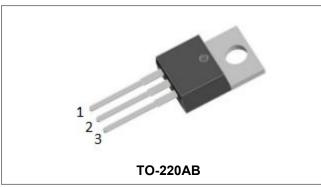






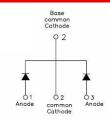
## MBR2060CTL SCHOTTKY RECTIFIER



#### **Features**

- 125°C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced
- · mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

# **Circuit Diagram**



#### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

### **Maximum Ratings:**

| Characteristics  | Symbol                               | Condition                                      | Max.                          | Units |
|--|--------------------------------------|--|-------------------------------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage | V <sub>RRM</sub><br>V <sub>RWM</sub> | -  | 60                            | V     |
| DC Blocking Voltage  Average Rectified Forward Current       | V <sub>R</sub>                       | 50% duty cycle @Tc=80°C, rectangular wave form | 10(Per Leg)<br>20(Per Device) | А     |
| Peak One Cycle Non-Repetitive Surge<br>Current(Per Leg)      | I <sub>FSM</sub>                     | 8.3ms, Half Sine pulse, T <sub>C</sub> = 25 °C | 150                           | А     |

#### **Electrical Characteristics:**

| Characteristics                | Symbol          | Condition  | Тур.  | Max.   | Units |
|--------------------------------|-----------------|--|-------|--------|-------|
| Forward Voltage Drop(Per Leg)* | V <sub>F1</sub> | @ 10A, Pulse, T <sub>J</sub> = 25 °C                             | 0.65  | 0.69   | V     |
|                                | V <sub>F2</sub> | @ 10A, Pulse, T <sub>J</sub> = 125 °C                            | 0.60  | 0.65   | V     |
| Reverse Current(Per Leg)*      | I <sub>R1</sub> | $@V_R = \text{rated } V_{R_1} T_J = 25 ^{\circ}\text{C}$         | 0.008 | 1.0    | mA    |
|                                | I <sub>R2</sub> | @V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 125 °C | 3     | 40     | mA    |
| Junction Capacitance(Per Leg)  | Ст              | $@V_R = 5V, T_C = 25 °C f_{SIG} = 1MHz$                          | 260   | 400    | pF    |
| Series Inductance(Per Leg)     | Ls              | Measured lead to lead 5 mm from package body                     | 8.0   | -      | nH    |
| Voltage Rate of Change         | dv/dt           | -  | -     | 10,000 | V/μs  |

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

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# **Thermal-Mechanical Specifications:**

| Characteristics                                 | Symbol            | Condition   | Specification | Units |
|---|-------------------|---|---------------|-------|
| Junction Temperature                            | TJ                | -   | -55 to +125   | °C    |
| Storage Temperature                             | T <sub>stg</sub>  | -   | -55 to +125   | °C    |
| Typical Thermal Resistance Junction to Case     | R <sub>0</sub> JC | DC operation  | 2.3           | °C/W  |
| Typical Thermal Resistance<br>Case to Heat Sink | R <sub>θCS</sub>  | Mounting surface, smooth and greased(only for TO-220) | 0.50          | °C/W  |
| Approximate Weight                              | wt                | greased(only for 10-220)                              | 2             | a     |

## **Ratings and Characteristics Curves**

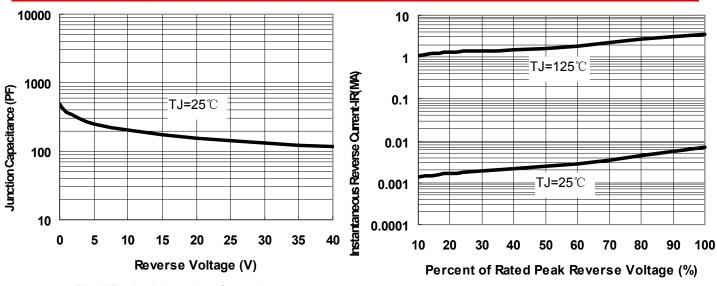


Fig.1-Typical Junction Capacitance

Fig.2-Typical Reverse Characteristics

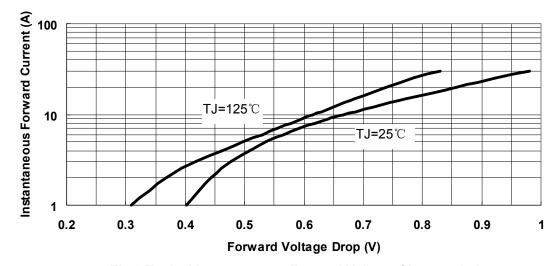


Fig.3-Typical Instantaneous Forward Voltage Characteristics

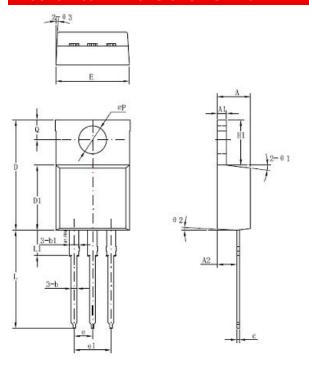
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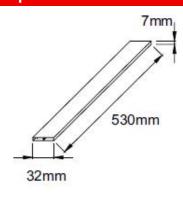


#### **Mechanical Dimensions TO-220AB**



|        | Dimensions in |         |       |
|--------|---------------|---------|-------|
| Symbol | millimeters   |         |       |
|        | Min           | Typical | Max   |
| Α      | 4.42          | 4.57    | 4.72  |
| A1     | 1.17          | 1.27    | 1.37  |
| A2     | 2.52          | 2.69    | 2.89  |
| b      | 0.71          | 0.81    | 0.96  |
| b1     | 1.17          | 1.27    | 1.37  |
| С      | 0.31          | 0.38    | 0.61  |
| D      | 14.94         | 15.24   | 15.54 |
| D1     | 8.85          | 9.00    | 9.15  |
| E      | 10.01         | 10.16   | 10.31 |
| е      |               | 2.54    |       |
| e1     | 4.98          | 5.06    | 5.18  |
| H1     | 6.04          | 6.24    | 6.44  |
| L      | 12.7          | 13.56   | 13.80 |
| L1     | 3.56          | 3.5     | 3.96  |
| ФР     | 3.74          | 3.84    | 4.04  |
| Q      | 2.54          | 2.74    | 2.94  |
| Θ1     |               | 7°      |       |
| Θ2     |               | 3°      |       |
| Θ3     |               | 4°      |       |

## **Tube Specification**



### **Marking Diagram**



Where XXXXX is YYWWL

MBR = Device Type
20 = Forward Current (20A)
60 = Reverse Voltage(60V)
CTL = Configuration

 SSG
 = SSG

 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

## **Ordering Information**

| Device     | Package            | Shipping     |  |
|------------|--------------------|--------------|--|
| MBR2060CTL | TO-220AB (Pb-Free) | 50 pcs/ tube |  |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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